

NI 622x Specifications

Specifications listed below are typical at 25 °C unless otherwise noted.

Analog Input

Number of channels

NI 6220/NI 6221 8 differential or
16 single ended

NI 6224/NI 6229 16 differential or
32 single ended

ADC resolution 16 bits

DNL No missing codes
guaranteed

INL Refer to the *AI
Absolute Accuracy
Table*

Sampling rate

Maximum 250 KS/s

Minimum 0 S/s

Timing accuracy 50 ppm of
sample rate

Timing resolution 50 ns

Input coupling DC

Input range ± 10 V, ± 5 V,
 ± 1 V, ± 0.2 V

Maximum working voltage

for analog inputs

(signal + common mode) ± 11 V of AI GND

CMRR (DC to 60 Hz) 95 dB

Input impedance

AI+ to AI GND >10 G Ω in parallel
with 100 pF

AI- to AI GND >10 G Ω in parallel
with 100 pF

Input bias current ± 100 pA

Crosstalk (at 100 kHz)

Adjacent channels -75 dB

Non-adjacent channels -90 dB

Small signal bandwidth

(-3 dB) 700 kHz

Input FIFO size 4,095 samples

Scan list memory 4,095 entries

Data transfers DMA
(scatter-gather),
interrupts,
programmed I/O

Overvoltage protection

(AI <0..31>, AI SENSE, AI SENSE 2)

Device on ± 25 V for up to
two AI pins

Device off ± 15 V for up to
two AI pins

Input current during

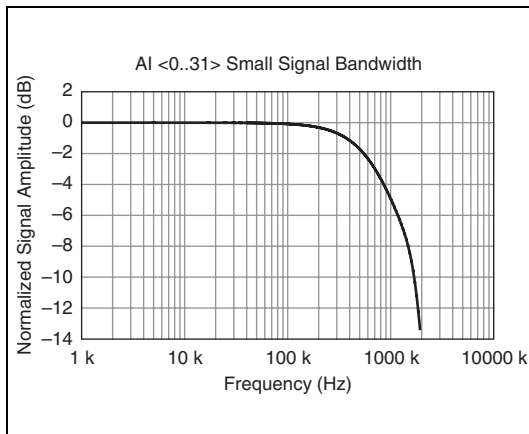
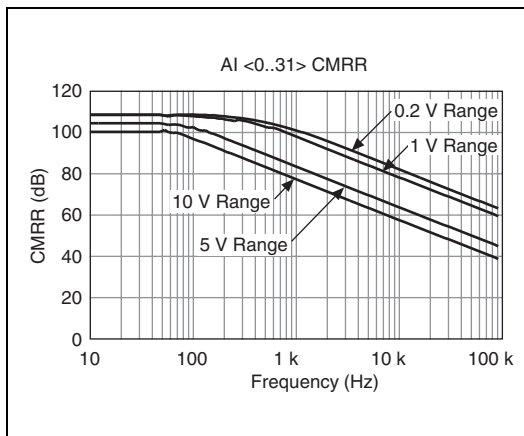
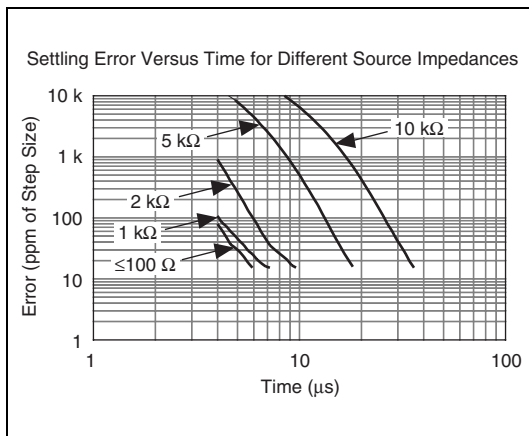
overvoltage condition ± 20 mA max/AI pin

Settling Time for Multichannel Measurements

Accuracy, full scale step, all ranges

- ±90 ppm of step
(±6 LSB).....4 μs convert interval
- ±30 ppm of step
(±2 LSB).....5 μs convert interval
- ±15 ppm of step
(±1 LSB).....7 μs convert interval

Typical Performance Graphs



Analog Output

Number of channels

NI 6220	0
NI 6221	2
NI 6224	0
NI 6229	4

DAC resolution 16 bits

DNL..... ± 1 LSB

Monotonicity 16 bit guaranteed

Maximum update rate

1 channel.....	833 kS/s
2 channels	740 kS/s per channel
3 channels	666 kS/s per channel
4 channels	625 kS/s per channel

Timing accuracy 50 ppm of
sample rate

Timing resolution 50 ns

Output range ± 10 V

Output coupling..... DC

Output impedance 0.2Ω

Output current drive ± 5 mA

Overdrive protection ± 25 V

Overdrive current 10 mA

Power-on state ± 20 mV

Power-on glitch 8.5 V peak for
14.5 ms

Output FIFO size..... 8,191 samples
shared among
channels used

Data transfers..... DMA
(Scatter-gather),
interrupts,
programmed I/O

AO waveform modes:

- Non-periodic waveform
- Periodic waveform regeneration mode from onboard FIFO
- Period waveform regeneration from host buffer including dynamic update

Settling time, full scale step
15 ppm (1 LSB) 6 μ s

Slew rate 15 V/ μ s

Glitch energy

Magnitude	100 mV
Duration	2.6 μ s

Calibration (AI and AO)

Recommended
warm-up time 15 minutes

Calibration interval..... 1 year

AI Absolute Accuracy Table

Nominal Range		Residual Gain Error (ppm of Reading)	Gain Tempco (ppm/°C)	Reference Tempco	Residual Offset Error (ppm of Range)	Offset Tempco (ppm of Range/°C)	INL Error (ppm of Range)	Random Noise, σ (μ Vrms)	Absolute Accuracy at Full Scale ¹ (μ V)	Sensitivity ² (μ V)
Positive Full Scale	Negative Full Scale									
10	-10	75	25	5	20	57	76	244	3,100	97.6
5	-5	85	25	5	20	60	76	122	1,620	48.8
1	-1	95	25	5	25	79	76	30	360	12.0
0.2	-0.2	135	25	5	80	175	76	13	112	5.2

AbsoluteAccuracy = Reading · (GainError) + Range · (OffsetError) + NoiseUncertainty

GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)

OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INL_Error

NoiseUncertainty = $\frac{\text{RandomNoise} \cdot 3}{\sqrt{100}}$ For a coverage factor of 3 σ and averaging 100 points.

¹ Absolute accuracy at full scale on the analog input channels is determined using the following assumptions:

TempChangeFromLastExternalCal = 10 °C

TempChangeFromLastInternalCal = 1 °C

number_of_readings = 100

CoverageFactor = 3 σ

For example, on the 10 V range, the absolute accuracy at full scale is as follows:

GainError = 75 ppm + 25 ppm · 1 + 5 ppm · 10

GainError = 150 ppm

OffsetError = 20 ppm + 57 ppm · 1 + 76 ppm

OffsetError = 153 ppm

NoiseUncertainty = $\frac{244 \mu\text{V} \cdot 3}{\sqrt{100}}$ NoiseUncertainty = 73 μ V

AbsoluteAccuracy = 10 V · (GainError) + 10 V · (OffsetError) + NoiseUncertainty AbsoluteAccuracy = 3,100 μ V

² Sensitivity is the smallest voltage change that can be detected. It is a function of noise.

AO Absolute Accuracy Table

Nominal Range		Residual Gain Error (ppm of Reading)	Gain Tempco (ppm/°C)	Reference Tempco	Residual Offset Error (ppm of Range)	Offset Tempco (ppm of Range/°C)	INL Error (ppm of Range)	Absolute Accuracy at Full Scale ¹ (µV)
Positive Full Scale	Negative Full Scale							
10	-10	90	10	5	40	5	128	3,230

¹ Absolute Accuracy at full scale numbers is valid immediately following internal calibration and assumes the device is operating within 10 °C of the last external calibration.

Absolute Accuracy = Output Value · (GainError) + Range · (OffsetError)
GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)
OffsetError = ResidualOffsetError + AOffsetTempco · (TempChangeFromLastInternalCal) + INL_Error

Digital I/O/PFI

Static Characteristics

Number of channels

NI 6220/NI 622124 total
8 (P0.<0..7>)
16 (PFI <0..15>/
P1/P2)

NI 6224/NI 622948 total
32 (P0.<0..31>)
16 (PFI <0..15>/
P1/P2)

Ground referenceD GND

Direction controlEach terminal
individually
programmable as
input or output

Pull-down resistor50 k Ω to 75 k Ω

Input voltage protection¹ ± 20 V on up to
two pins

Waveform Characteristics (Port 0 Only)

Terminals used

NI 6220/NI 6221Port 0 (P0.<0..7>)
NI 6224/NI 6229Port 0 (P0.<0..31>)

Port/sample size

NI 6220/NI 6221Up to 8 bits
NI 6224/NI 6229Up to 32 bits

Waveform generation

(DO) FIFO2,047 samples

Waveform acquisition

(DI) FIFO2,047 samples

DO or DI Sample

Clock frequency0 to 1 MHz

DO or DI Sample

Clock source..... Any PFI, RTSI,
AI Sample or
Convert Clock,
AO Sample Clock,
DI Change Event,
Ctr *n* Internal
Output, and many
other signals

PFI/Port 1/Port 2 Functionality

Functionality Static digital input,
static digital output,
timing input,
timing output

Timing output sources..... Many AI, AO,
counter, DI,
DO timing signals

Debounce filter settings 125 ns, 6.425 μ s,
2.54 ms, disable;
high and low
transitions;
selectable per input

¹ Stresses beyond those listed under *Input voltage protection* may cause permanent damage to the device.

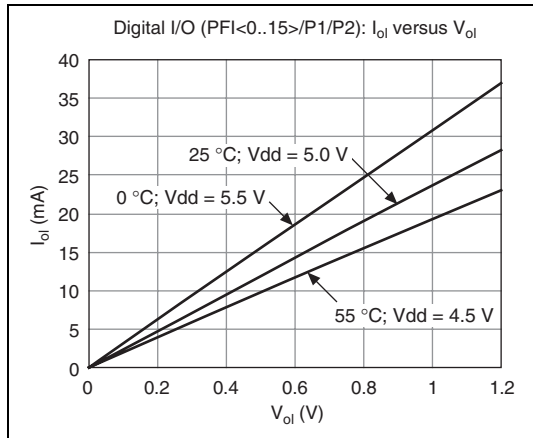
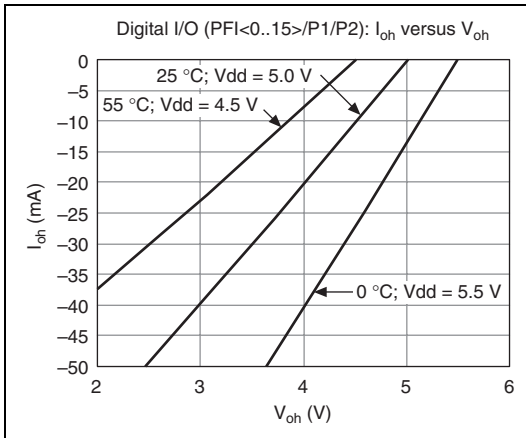
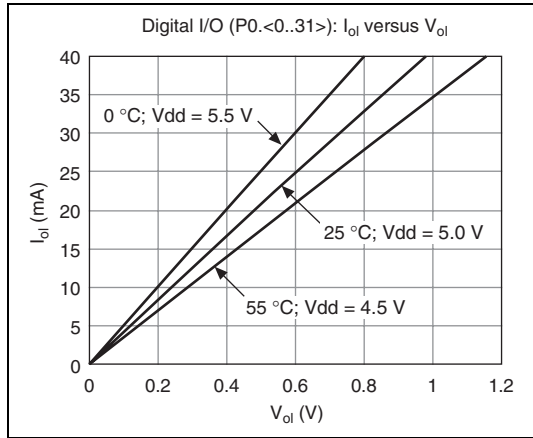
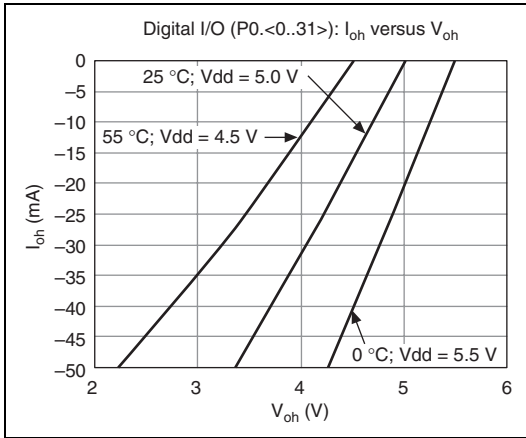
Recommended Operation Conditions

Level	Min	Max
Input high voltage (V_{IH})	2.2 V	5.25 V
Input low voltage (V_{IL})	0 V	0.8 V
Output high current (I_{OH})		
P0.<0..31>	—	-24 mA
PFI <0..15>/P1/P2	—	-16 mA
Output low current (I_{OL})		
P0.<0..31>	—	24 mA
PFI <0..15>/P1/P2	—	16 mA

Electrical Characteristics

Level	Min	Max
Positive-going threshold (V_{T+})	—	2.2 V
Negative-going threshold (V_{T-})	0.8 V	—
Delta VT hysteresis ($V_{T+} - V_{T-}$)	0.2 V	—
I_{IL} input low current ($V_{in} = 0$ V)	—	-10 μ A
I_{IH} input high current ($V_{in} = 5$ V)	—	250 μ A

Digital I/O Characteristics



General-Purpose Counter/Timers

Number of counter/timers ...	2
Resolution.....	32 bits
Counter measurements	Edge counting, pulse, semi-period, period, two-edge separation
Position measurements.....	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	80 MHz, 20 MHz, 0.1 MHz
External base clock frequency	0 MHz to 20 MHz
Base clock accuracy	50 ppm
Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down
Routing options for inputs...	Any PFI, RTSI, PXI_TRIG, PXI_STAR, analog trigger, many internal signals
FIFO	2 samples
Data transfers.....	Dedicated scatter-gather DMA controller for each counter/timer; interrupts; programmed I/O

Frequency Generator

Number of channels.....	1
Base clocks	10 MHz, 100 kHz
Divisors	1 to 16
Base clock accuracy	50 ppm
Output can be available on any PFI or RTSI terminal.	

Phase-Locked Loop (PLL)

Number of PLLs.....	1
Reference signal	PXI_STAR, PXI_CLK10, RTSI <0..7>
Output of PLL	80 MHz timebase; other signals derived from 80 MHz timebase including 20 MHz and 100 kHz timebases

External Digital Triggers

Source	Any PFI, RTSI, PXI_TRIG, PXI_STAR
Polarity	Software-selectable for most signals
Analog input function.....	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Convert Clock, Sample Clock Timebase
Analog output function.....	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase

Counter/timer functions Gate, Source,
HW_Arm, Aux,
A, B, Z, Up_Down,

Digital waveform generation
(DO) function Sample Clock

Digital waveform acquisition
(DI) function Sample Clock

Device-To-Device Trigger Bus

PCI devices RTSI <0..7>¹

PXI devices PXI_TRIG <0..7>,
PXI_STAR

Output selections 10 MHz Reference
Clock; frequency
generator output;
many internal
signals

Debounce filter settings 125 ns, 6.425 μ s,
2.54 ms, disabled;
high and low
transitions;
selectable per input

Bus Interface

PCI or PXI 3.3 V or 5 V signal
environment

DMA channels 6, analog input,
analog output,
digital input,
digital output,
counter/timer 0,
counter/timer 1

Power Requirements

Current draw from bus during no-load condition

+5 V	0.02 A
+3.3 V	0.25 A
+12 V	0.15 A

Current draw from bus during AI and AO
overvoltage condition

+5 V	0.02 A
+3.3 V	0.25 A
+12 V	0.25 A

Power available from

+5 V terminal 1 A max, each
connector, with
self-resetting fuse

Other power limit for

PXI devices Current drawn from
+5 V terminals and
all P0/PFI/P1/P2
terminals should not
exceed 2 A

Physical Requirements

Printed circuit board dimensions

NI PCI 6220/6221/ 6224/6229	9.7 cm \times 15.5 cm (3.8 in. \times 6.1 in.)
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NI PXI 6220/6221/ 6224/6229	Standard 3U PXI
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I/O connector

NI 6220/NI 6221	1 68-pin VHDCI
NI 6224/NI 6229	2 68-pin VHDCI

¹ In other sections of this document, *RTSI* refers to *RTSI <0..7>* for PCI devices or *PXI_TRIG <0..7>* for PXI devices.

Maximum Working Voltage¹

NI 6220/NI 6221/NI 6224/NI 6229

- Channel-to-earth 11 V, Installation Category I
- Channel-to-channel 11 V, Installation Category I

Environmental

- Operating temperature 0 to 55 °C
- Storage temperature -20 to 70 °C
- Humidity 10 to 90% RH, noncondensing
- Maximum altitude 2,000 m
- Pollution Degree (indoor use only) 2

Safety

This product is designed to meet the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1
- CAN/CSA C22.2 No. 61010-1



Note For UL and other safety certifications, refer to the product label, or visit ni.com/certification, search by model number or product line, and click the appropriate link in the Certification column.

Electromagnetic Compatibility

Emissions EN 55011 Class A at 10 m; FCC Part 15A above 1 GHz

Immunity EN 61326:1997 + A2:2001, Table 1

CE, C-Tick, and FCC Part 15 (Class A) Compliant



Note For EMC compliance, operate this device with shielded cabling.

CE Compliance

This product meets the essential requirements of applicable European Directives, as amended for CE marking, as follows:

Low-Voltage Directive (safety) 73/23/EEC

Electromagnetic Compatibility Directive (EMC) 89/336/EEC



Note Refer to the Declaration of Conformity (DoC) for this product for any additional regulatory compliance information. To obtain the DoC for this product, visit ni.com/certification, search by model number or product line, and click the appropriate link in the Certification column.

¹ *Maximum working voltage* refers to the signal voltage plus the common-mode voltage.

